

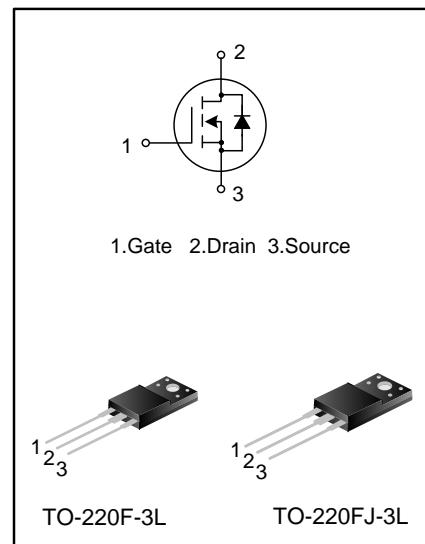


## 10A, 700V N-CHANNEL MOSFET

### GENERAL DESCRIPTION

SVF10N70F/FJ is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan proprietary F-Cell™ high-voltage planar VDMOS technology. The improved process and cell structure have been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

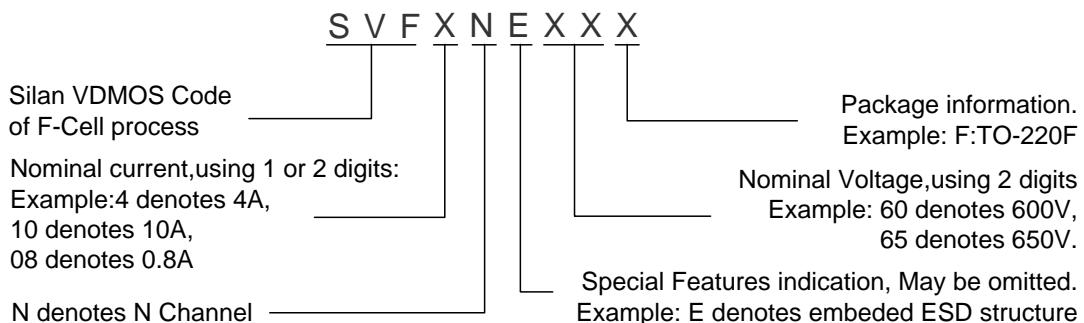
These devices are widely used in AC-DC power supplies, DC-DC converters and H-bridge PWM motor drivers.



### FEATURES

- 10A, 700V,  $R_{DS(on)(typ.)} = 0.95\Omega$  @  $V_{GS} = 10V$
- Low gate charge
- Low Crss
- Fast switching
- Improved dv/dt capability

### NOMENCLATURE



### ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing
SVF10N70F	TO-220F-3L	SVF10N70F	Pb free	Tube
SVF10N70FJ	TO-220FJ-3L	SVF10N70FJ	Pb free	Tube

## ABSOLUTE MAXIMUM RATINGS ( $T_c=25^\circ\text{C}$ unless otherwise noted)

Characteristics	Symbol	Ratings	Unit
Drain-Source Voltage	$V_{DS}$	700	V
Gate-Source Voltage	$V_{GS}$	$\pm 30$	V
Drain Current	$I_D$	10	A
$T_c = 100^\circ\text{C}$		5.5	
Drain Current Pulsed	$I_{DM}$	40	A
Power Dissipation( $T_c=25^\circ\text{C}$ ) -Derate above $25^\circ\text{C}$	$P_D$	50	W
		0.4	W/ $^\circ\text{C}$
Single Pulsed Avalanche Energy (Note 1)	$E_{AS}$	608	mJ
Reverse Diode dv/dt (Note 2)	dv/dt	4.5	V/ns
MOSFET dv/dt Ruggedness (Note 3)	dv/dt	50	V/ns
Operation Junction Temperature Range	$T_J$	-55~+150	$^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	-55~+150	$^\circ\text{C}$

## THERMAL CHARACTERISTICS

Characteristics	Symbol	Ratings	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.5	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	$^\circ\text{C}/\text{W}$

## ELECTRICAL CHARACTERISTICS ( $T_c=25^\circ\text{C}$ unless otherwise noted)

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain -Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0\text{V}$ , $I_D=250\mu\text{A}$	700	--	--	V
Drain-Source Leakage Current	$I_{DS(on)}$	$V_{DS}=700\text{V}$ , $V_{GS}=0\text{V}$	--	--	1.0	$\mu\text{A}$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 30\text{V}$ , $V_{DS}=0\text{V}$	--	--	$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}$ , $I_D=250\mu\text{A}$	3.0	--	5.0	V
Static Drain- Source On State Resistance	$R_{DS(on)}$	$V_{GS}=10\text{V}$ , $I_D=5.0\text{A}$	--	0.95	1.2	$\Omega$
Input Capacitance	$C_g$	f=1.0MHz	--	16	--	$\Omega$
Input Capacitance	$C_{iss}$	$V_{DS}=25\text{V}$ , $V_{GS}=0\text{V}$ , f=1.0MHz	--	1525	--	pF
Output Capacitance	$C_{oss}$		--	129	--	
Reverse Transfer Capacitance	$C_{rss}$		--	3.5	--	
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=350\text{V}$ , $I_D=10\text{A}$ , $R_G=25\Omega$ (Note 4,5)	--	40	--	ns
Turn-on Rise Time	$t_r$		--	74	--	
Turn-off Delay Time	$t_{d(off)}$		--	52	--	
Turn-off Fall Time	$t_f$		--	35	--	
Total Gate Charge	$Q_g$	$V_{DS}=560\text{V}$ , $I_D=10\text{A}$ , $V_{GS}=10\text{V}$ (Note 4,5)	--	28	--	nC
Gate-Source Charge	$Q_{gs}$		--	13	--	
Gate-Drain Charge	$Q_{gd}$		--	9.5	--	



## SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	$I_S$	Integral Reverse p-n Junction Diode in the MOSFET	--	--	10	A
Pulsed Source Current	$I_{SM}$		--	--	40	
Diode Forward Voltage	$V_{SD}$	$I_S=10A, V_{GS}=0V$	--	--	1.3	V
Reverse Recovery Time	$T_{rr}$	$I_S=10A, V_{GS}=0V,$ $dI_F/dt=100A/\mu s$	--	571	--	ns
Reverse Recovery Charge	$Q_{rr}$	(Note 4)	--	4.7	--	$\mu C$

**Notes:**

1.  $L=30M\Omega$ ,  $I_{AS}=5.82A$ ,  $V_{DD}=100V$ ,  $R_G=25\Omega$ , starting temperature  $T_J=25^\circ C$ ;
2.  $V_{DS}=0\sim400V$ ,  $I_{SD}<=10A$ ,  $T_J=25^\circ C$ ;
3.  $V_{DS}=0\sim480V$ ;
4. Pulse Test: Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$ ;
5. Essentially independent of operating temperature.

## TYPICAL CHARACTERISTICS

Figure 1. On-Region Characteristics

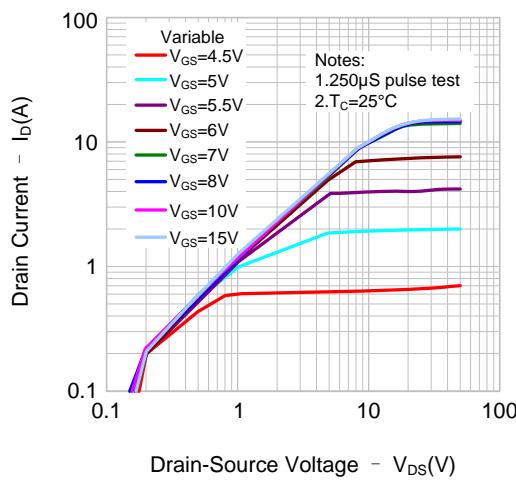


Figure 2. Transfer Characteristics

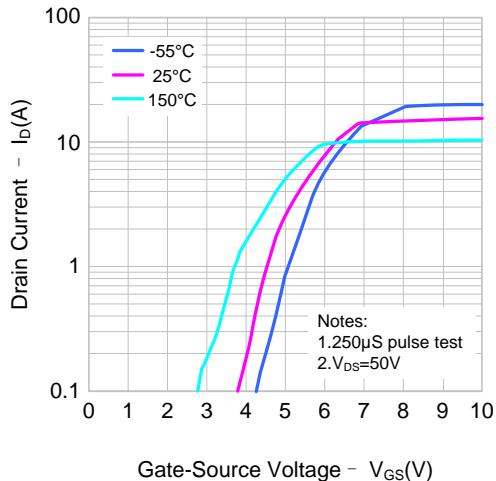


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

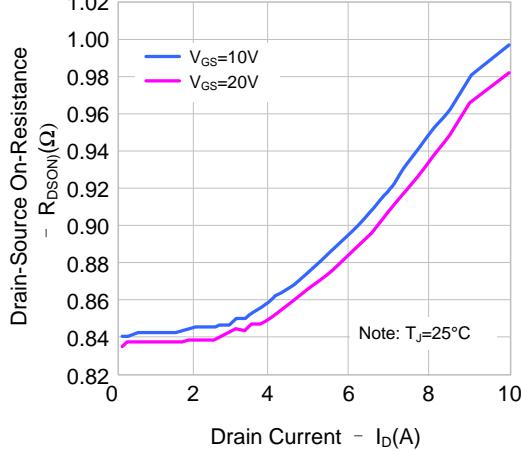
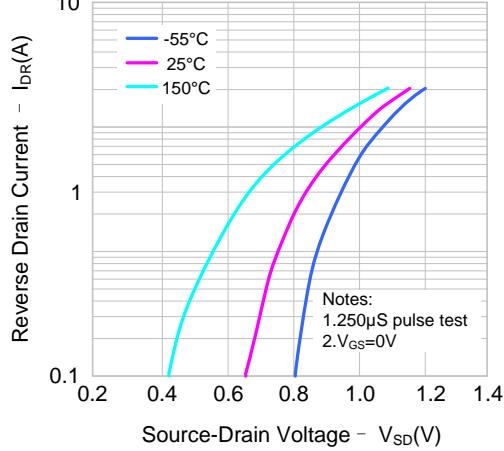
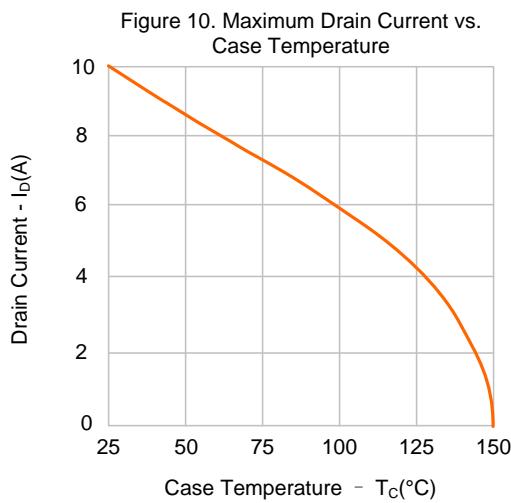
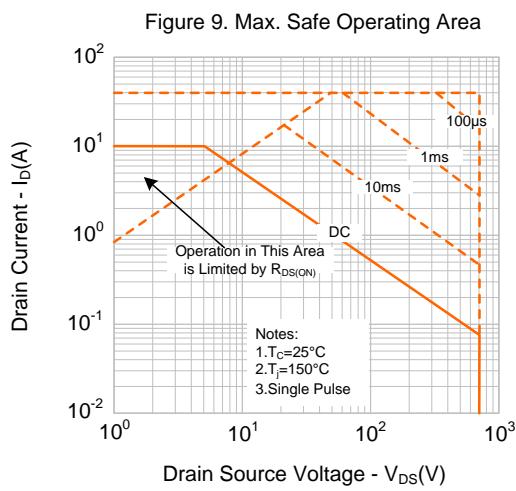
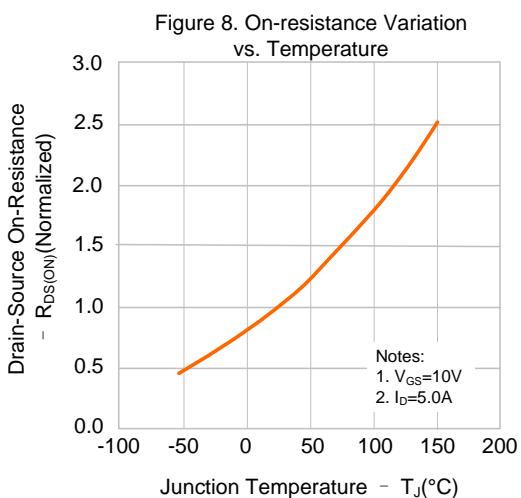
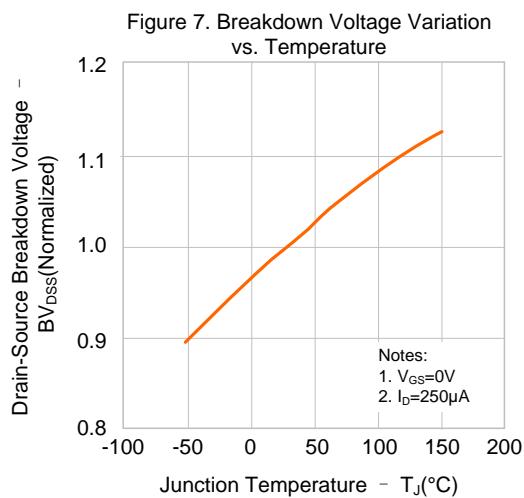
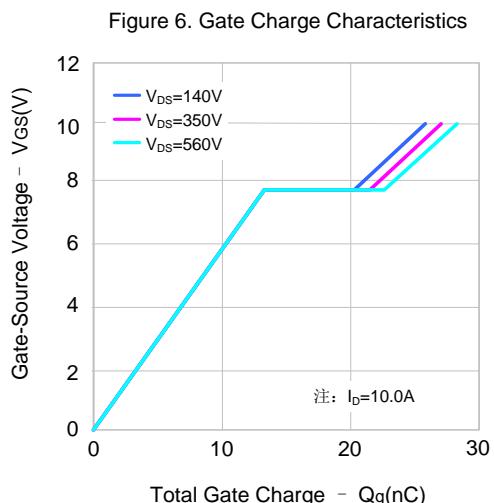
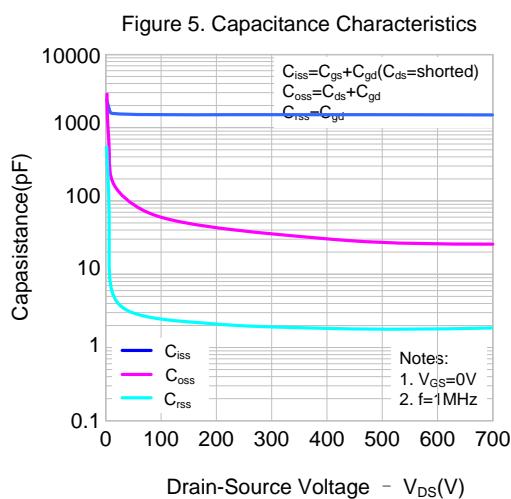


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature





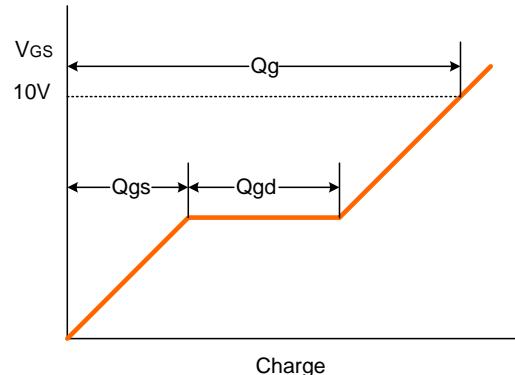
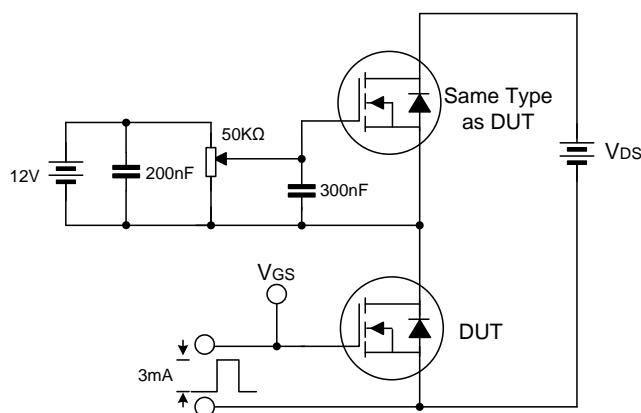
## TYPICAL CHARACTERISTICS (continued)



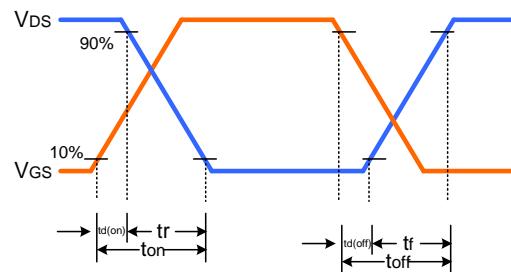
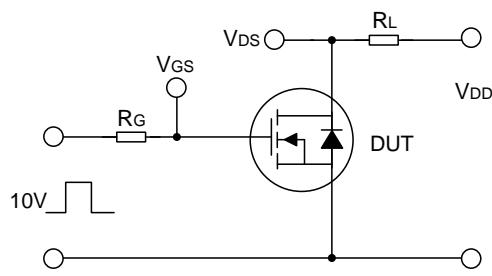


## TYPICAL TEST CIRCUIT

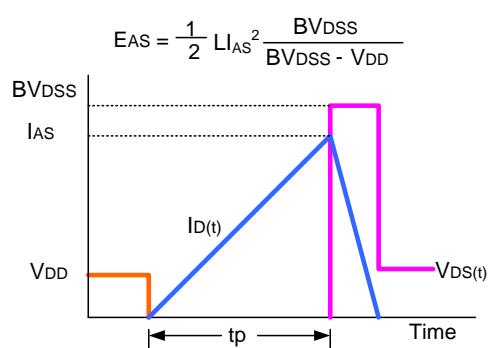
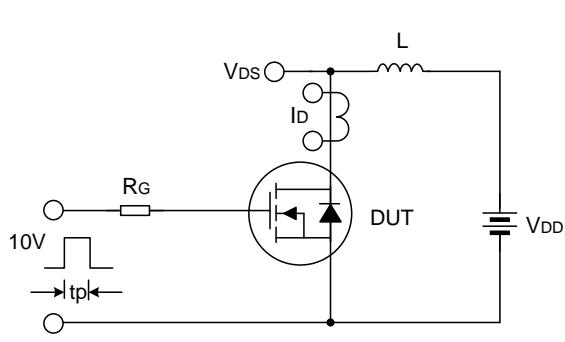
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



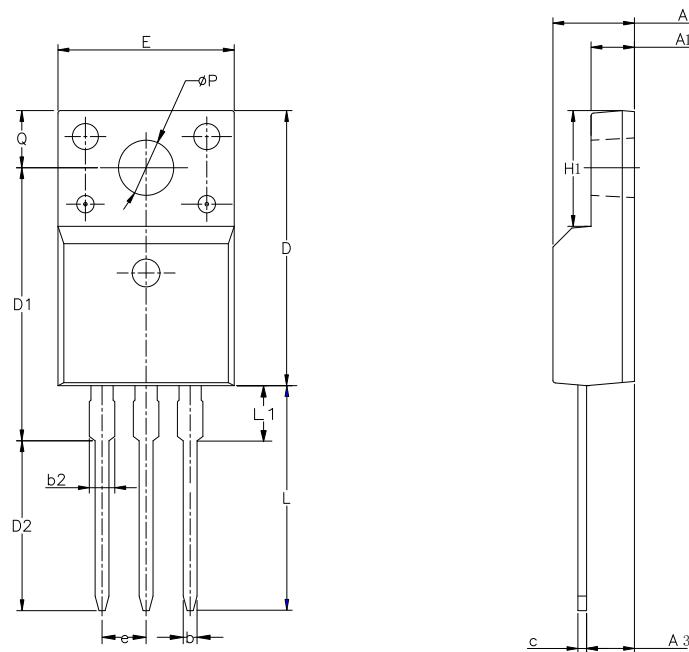
Unclamped Inductive Switching Test Circuit & Waveform



## PACKAGE OUTLINE

**TO-220F-3L**

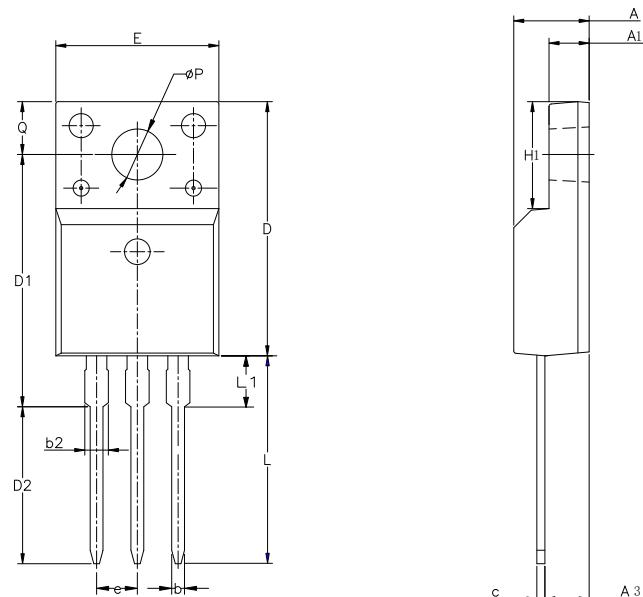
UNIT: mm



SYMBOL	MIN	NOM	MAX
A	4.42	4.70	5.02
A1	2.30	2.54	2.80
A3	2.50	2.76	3.10
b	0.70	0.80	0.90
b2	—	—	1.47
c	0.35	0.50	0.65
D	15.25	15.87	16.25
D1	15.30	15.75	16.30
D2	9.30	9.80	10.30
E	9.73	10.16	10.36
e	2.54BCS		
H1	6.40	6.68	7.00
L	12.48	12.98	13.48
L1	/	/	3.50
ØP	3.00	3.18	3.40
Q	3.05	3.30	3.55

**TO-220FJ-3L**

UNIT: mm



SYMBOL	MIN	NOM	MAX
A	4.42	4.70	5.02
A1	2.30	2.54	2.80
A3	2.50	2.76	3.10
b	0.55	0.70	0.85
b2	—	—	1.29
c	0.35	0.50	0.65
D	15.25	15.87	16.25
D1	13.97	14.47	14.97
D2	10.58	11.08	11.58
E	9.73	10.16	10.36
e	2.54BCS		
H1	6.40	6.68	7.00
L	12.48	12.98	13.48
L1	—	—	2.00
ØP	3.00	3.18	3.40
Q	3.05	3.30	3.55

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Rev.: 1.6

**Revision History:**

1. Add the package outline of TO-220FJ-3L

Rev.: 1.5

**Revision History:**

1. Modify the Electrical Characteristics
2. Add dv/dt and Rg
3. Update Fig 5

Rev.: 1.4

**Revision History:**

1. Modify the Electrical Characteristics
2. Update Fig 6

Rev.: 1.3

**Revision History:**

1. Modify the Electrical Characteristics

Rev.: 1.2

**Revision History:**

1. Modify the package information of TO-220F-3L

Rev.: 1.1

**Revision History:**

1. Modify the thermal characteristics

Rev.: 1.0

**Revision History:**

1. First release